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Thermoelectric effect spectroscopy of deep levels in semi-insulating GaN

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The report of thermoelectric effect spectroscopy (TEES) applied on semi-insulating GaN was presented. The type of TEES setup, especially suitable for film-on-substrate samples, was devised. TEES enabled determination of sign of observed deep traps. Using TEES and thermally stimulated current spectroscopy measurements in combination with the simultaneous multiple peak analysis formalism all important trap parameters were determined. The shallowest identified electron and hole traps had activation energies $E_c - 0.09 \, \text{eV}$ and $E_v + 0.167 \, \text{eV}$, respectively. Results indicate that both these traps, oppositely charged are present in the studied material in relatively high concentrations causing the electrical compensation and high resistivity. © 2002 American Institute of Physics. [DOI: 10.1063/1.1504168]

Gallium nitride (GaN) is one of the most promising III-V nitride semiconductors due to its unique electronic and optical properties. Commercial short wavelength light emitting diodes as well as laser diodes, field effect transistors, and ultraviolet detectors are being developed. 1,2 For both electrical and optical devices, defects with deep levels can be very important, and thus must be understood.3 There are several reports^{4,5} on deep levels in conductive GaN, obtained by using deep level transient spectroscopy (DLTS). Although there are number of studies of semi-insulating (SI) GaN⁶⁻⁹ very little is known about deep centers in this material. Thermally stimulated current (TSC) spectroscopy is a useful method for characterization of high-resistivity samples and it has been applied extensively to SI GaAs. 10-12 On the other hand, it has been employed only a few times for SI GaN. 9,13 In these articles, a variety of deep levels were reported. Huang et al. (Ref. 13) reported five main deep levels (0.11, 0.24, 0.36, 0.53, and 0.62 eV), while Look et al.9 have found two shallow traps (0.09 and 0.17 eV) and at least one deeper trap at 130 K. TSC cannot distinguish whether the observed levels are electron or hole traps.

In this article, deep levels in SI GaN, grown by molecular beam epitaxy (MBE), 9 were studied using thermoelectric effect spectroscopy (TEES). In contrast to TSC, TEES can determine the sign of the traps, so it can distinguish whether the observed levels are electron or hole traps. It is of obvious importance for the more accurate assignation of defect microscopic origin as well as for better understanding of the compensation mechanism in highly resistive or SI GaN. In addition, TSC and low-temperature photoconductivity ($I_{\rm PC}$) measurements were performed. The sample was a 6- μ mthick SI GaN layer grown at 800 °C on c-plane sapphire. TEES was developed 14 and later successfully applied in SI GaAs. $^{14-16}$ In TEES, the deep traps are filled by illumination with white light at 86 K. The subsequent heating in the dark

at a constant rate causes the release of trapped carriers. In addition to the temperature ramp, a temperature gradient is established along the sample, inducing a drift of the liberated charge carriers to the electric contacts, producing the thermoelectric effect and therefore the current in the outer circuit.¹⁴ The sign of the current depends on the type of the dominant charge carriers at a particular temperature, thus enabling a distinction between electron and hole traps. A simplified experimental configuration for TEES measurements was used, in which the temperature gradient along the sample was produced by adding a thin plate of a thermal conductor (copper) under one half of the sample and a thermal insulator (teflon) of equal thickness under the other half. This simple configuration excludes the additional heater, used in the original setup, ¹⁴ eliminating its damaging impact on measurement quality. Thus, the resulting gradient proved sufficient to produce TEES currents (I_{TEES}) of a few picoamperes, which are values comparable to the ones obtained in a standard TEES experiment. 14 The TSC measurement was performed using a standard procedure, often used for SI GaAs characterization, and which is described in detail elsewhere. 11,12 Figure 1 presents TEES and TSC spectra, obtained with different heating rates (β =0.4, 0.6, or 0.8 K/s). Both the TEES and TSC intensities increase with an increase of β , accompanied by a shift of the peak maxima towards higher temperatures. The whole TSC signal is of the same sign, since the charge released from both trap types contributes to the TSC current. However, the analogous TEES signal-which reflects the difference between positive and negative charges—reveals that carriers giving rise to TSC peak A, (near 100 K), are partly electrons and partly holes, while the majority of carriers related to the TSC signal at higher temperatures has a positive sign. Two arguments support the assignment of peak A to a composite peak, resulting from both positive and negative carriers: (i) the maximum of peak A-at any β —does not occur at the same T in TSC and TEES, as would have been expected if both of the "sub" peaks had had the same sign; 17 and (ii) for lower β , the integral of the TEES

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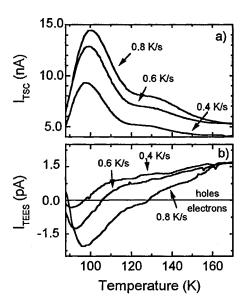


FIG. 1. (a) and (b) TSC and TEES curves, respectively, measured at heating rates β =0.4, 0.6, and 0.8 K/s.

negative peak covers a narrower T range, and the peak maximum is shifted towards lower T in comparison to the maximum of A in the TSC spectra. This agrees with the notion that for lower β the thermoelectric-effect driven separation of electrons and holes becomes less effective, giving rise to a more intense recombination of liberated electrons and holes.

Solely from the shape of TSC peak A, Look *et al.*⁹ concluded that A has to be a multicomponent peak and extracted activation energies $E_{A1} = 0.09 \pm 0.01 \,\text{eV}$ and $E_{A2} = 0.17 \pm 0.05 \,\text{eV}$ for two of its main components. In this article we have applied simultaneous multiple peak analysis (SIMPA)^{12,17} to the whole TSC spectrum to determine all components of peak A. As shown in Fig. 2, we have successfully fitted peak A with three deep traps A_1 , A_2 , and A_3 .

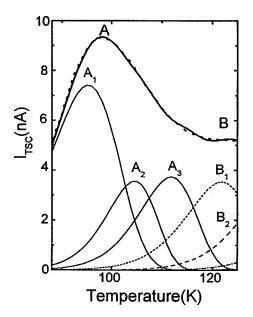


FIG. 2. SIMPA fit (thick solid curve) of the measured TSC spectrum (thick dotted curve). A_1 , A_2 , A_3 , B_1 , and B_2 are particular SIMPA peaks representing components of peaks A and B, respectively.

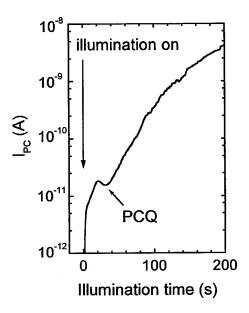


FIG. 3. Time evolution of photocurrent ($I_{\rm PC}$) during white light illumination at 86 K.

The sign of the TEES spectra indicates that A_1 , the lowestenergy trap contributing to the A peak, is an electron trap, and the highest-energy trap, A_3 , is a hole trap. As the TEES signal changes its sign just in the T range corresponding to the A_2 trap, it is not possible to determine its sign with certainty. Namely, the activation energies of all three A_1-A_3 traps are relatively close, and the TEES signal from the A2 trap might be overpowered either by electron trap A_1 or by hole trap A_3 . The SIMPA analysis gives the following trap parameters: $E_{A1} = E_C - (0.090 \pm 0.004) \text{ eV}, \ \sigma_{A1} = (4.5 \pm 1.5) \times 10^{-22} \text{ cm}^2, \text{ and } E_{A3} = E_V + (0.167 \pm 0.008) \text{ eV}, \ \sigma_{A3} = (5.0 \pm 1.5) \times 10^{-19} \text{ cm}^2.$ The value of σ_{A2} comes out either 9.4 $\times 10^{-19}$ or 6.7×10^{-19} cm², depending on whether A_2 is an electron or a hole trap. The product $N\tau\mu$, where N is trap concentration, τ is a free-carrier lifetime, and μ is the carrier mobility, is 7.8×10^{13} , 2.5×10^{13} , 3.1×10^{13} cm⁻¹ V⁻¹, for traps A_1 , A_2 , and A_3 , respectively. This suggests high concentrations of all three traps, in the $10^{17}\,\mathrm{cm}^{-3}$ range.

The temporal evolution of $I_{PC}(t)$ during constantintensity white-light illumination at 86 K is presented in Fig. 3. I_{PC} shows clear photocurrent quenching (PCQ) in the early stage of the transient. Since photogeneration constantly supplies new n and p, the observed decrease of $I_{PC}(t)$ can be explained if there is a sudden switch between the dominant type of carrier in I_{PC} during illumination. Then considerable changes in p and n concentrations, their recombination rate and mobility would take place. Computer simulations have shown¹⁸ that such a switch—and the resulting PCQ—will occur in samples having "fast" and "slow" traps of opposite sign but comparable concentrations, due to preferential trapping of either electrons or holes during the early stages of illumination. An analogous quenching of I_{PC} was observed previously in SI GaAs during low-T illumination 14,19,20 in samples which also contained both electron and hole deep traps with quite different cross sections.¹⁴

Having now determined not only the energy but also the sign of the observed deep levels, the question of microscopic

origin of donor level at $E_c - 0.09 \,\mathrm{eV}$ and acceptor level at $E_v + 0.167 \,\mathrm{eV}$, as well as the nature of the compensation mechanism can be analyzed with more plausibility. Based on the comparison of trap parameters, the most probable candidate for the electron trap A₁ is a defect related to the N vacancy. From the temperature-dependent Hall data, the thermal activation energy (E_T) for the N-vacancy donor, induced by electron irradiation (EI) has been determined²¹ to be 0.07 eV. In addition, a broad, low-temperature DLTS peak (E), induced by 1 MeV EI, has an apparent activation energy of $0.18 \text{ eV}^{.22}$ However, detailed DLTS fitting shows that (i) E consists of ED1 and ED2; (ii) both centers have the same E_T , 0.06 eV, which is very close to the 0.07 eV found for the EI-induced N-vacancy donor; and (iii) both centers have different and small capture cross sections $(1-3\times10^{-20}\,\mathrm{cm}^2)$ for ED1 and $5-8\times10^{-19}$ cm² for ED2), with that of ED2 being temperature dependent and having an activation energy (E_{σ}) of 0.06 eV.²³ We speculate that the hole trap (A_3) is due to the Ga vacancy, which is often the dominant acceptor in undoped GaN, especially that grown by hydride vapor phase epitaxy, as confirmed by positron annihilation studies.^{24,25} According to theoretical calculations,²⁶ (i) the N vacancy (a donor) has the lowest formation energy in p-type GaN, and the Ga vacancy (an acceptor) in n-type GaN; and (ii) the isolated Ga vacancy in the negative charge state is triply occupied, with levels close to the valence band. There are many reports about deep levels related to impurity acceptors [such as Mg (Refs. 27 and 28)], however, so far there are no reports about any DLTS centers related to the Ga vacancy. It is possible that the TSC/TEES trap A_3 at $E_n + 0.167$ eV is related to Ga vacancy. Since this activation energy is close to the reported activation energies for Mg (such as 136 meV by admittance measurements, 27 135–155 meV by Hall effect measurements, and 80-115 meV by admittance measurements, 28 respectively), we should not rule out the possibility that A_3 is due to Mg, owing to possible contamination and memory effect during MBE growth. To clarify this issue, further TEES studies on high-resistive or semiinsulating GaN samples grown by other techniques are necessary.

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